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APPLICATION NO.		FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/005,402		12/05/2001	Alan G. Wood	2825.10US (90-0051.12)	1641
24247	7590	10/26/2006		EXAMINER	
TRASK BI	RITT		KARLSEN, ERNEST F		
P.O. BOX 2550 SALT LAKE CITY, UT 84110				ART UNIT	PAPER NUMBER
				2829	.,
				DATE MAILED: 10/26/200	DATE MAILED: 10/26/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)				
		10/005,402	WOOD ET AL.				
	Office Action Summary	Examiner	Art Unit				
		Ernest F. Karlsen	2829				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply							
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).							
Status							
2a)⊠	Responsive to communication(s) filed on <u>18 Au</u> This action is <b>FINAL</b> . 2b) This Since this application is in condition for allowar closed in accordance with the practice under E	action is non-final. nce except for formal matters, pro					
Disposition of Claims							
5)□ 6)⊠ 7)□	Claim(s) <u>1-8</u> is/are pending in the application.  4a) Of the above claim(s) <u>6-8</u> is/are withdrawn to Claim(s) is/are allowed.  Claim(s) <u>1-5</u> is/are rejected.  Claim(s) is/are objected to.  Claim(s) are subject to restriction and/or						
Applicati	on Papers						
10)	The specification is objected to by the Examine The drawing(s) filed on is/are: a) access Applicant may not request that any objection to the Replacement drawing sheet(s) including the correction to the coath or declaration is objected to by the Examine The oath or declaration is objected to by the Examine The specific and the specifi	epted or b) objected to by the Eddrawing(s) be held in abeyance. See ion is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).				
Priority u	nder 35 U.S.C. § 119						
<ul> <li>12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).</li> <li>a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority documents have been received.</li> <li>2. Certified copies of the priority documents have been received in Application No.</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>							
2) Notice 3) Inform	t(s) e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO/SB/08) r No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	ite				

Claims 6-8 are withdrawn from further consideration pursuant to 37 CFR 1.142(b) as being drawn to a nonelected inventions and/or species, there being no allowable generic or linking claim. Election was made without traverse in the reply filed on February 21, 2006.

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-5 are rejected under 35 U.S.C. 103(a) as being unpatentable over Corbett it al in view of Elder et al. Corbett et al show that claimed except that the apparatus is for test of die instead of wafers. Elder et al teach that what can be used to test die can be used to test a wafer. It would have been obvious to one of ordinary skill in the art at the time of the invention to have adapted the apparatus of Corbett et al to test wafers as taught by Elder et al because one of ordinary skill in the art would realize that so doing would enable cheaper testing of wafers.

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Applicants argue that one skilled in the art would not be able to figure out how to modify the die tester of Corbett et al to test wafers even with the suggestion by Elder et al that a device for testing die can be modified to test a multichip hybrid or a complete wafer. The word wafer in the semiconductor industry generally means a slice of semiconductor material with plural die formed thereon. It is noted that claim 1 calls for a plurality of semiconductor dice in wafer form. Presumably such means at least two die on a wafer and of course there could be hundreds or even thousands. So at one limit there are two die on a wafer. A wafer does not have to round and most are not round because they have an orientation detent. Presumably there could be such a thing as a square wafer. In such a scenario, we have at a limit, a square (or some other shape) wafer with two die formed thereon. Back in the 1970s there were numerous integrated circuit devices available that had plural independent integrated circuits, such as operational amplifiers, on a single chip. Such would be equivalent to a square wafer with two die thereon. Presumably such devices could be tested using the apparatus of Corbett et al. Unless memory fails the Examiner, such devices often had a number designation that included "74" such as "7405" when packaged. The Examiner maintains that at the time

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of the invention one skilled in the art would be able to figure out how to use the apparatus of Corbett et al to test two die on a wafer given the suggestion of Elder et al.

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication should be directed to

Ernest F. Karlsen at telephone number 571-272-1961. mest of Karlen

Ernest F. Karlsen

October 20, 2006\

PRIMARY EXAMINER